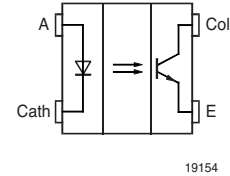


Subminiature Transmissive Optical Sensor with Phototransistor Output

Description

TCPT1200X01 has a compact construction where emitter and detector is located face to face on the same optical axes. The operating wavelength is 950 nm.



Features

- IR Emitter wavelength 950 nm
- Gap 2 mm
- Package height: 4 mm
- Surface Mountable Device (SMD)
- Option X01: High reliability device for advanced applications
- Lead-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

Applications

- Accurate position sensor for encoder
- Detection of motion direction
- Detection of motor speed and direction where high reliability performance is required

Parts Table

Part	Resolution	Aperture	MOQ	Remarks
TCPT1200X01	0.24 mm	0.3 mm	2000 pc	Tape and Reel

Absolute Maximum Ratings

Coupler

Parameter	Test condition	Symbol	Value	Unit
Total power dissipation	$T_{amb} \leq 25^{\circ}\text{C}$	P_{tot}	150	mW
Ambient temperature range		T_{amb}	-40 to +85	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	-40 to +100	$^{\circ}\text{C}$
Soldering temperature	in accordance to released reflow solder profile	T_{sd}	260	$^{\circ}\text{C}$

Input (Emitter)

Parameter	Test condition	Symbol	Value	Unit
Reverse voltage		V_R	5	V
Forward current		I_F	25	mA
Pulse forward current	$t_p = 0.1 \text{ ms}; t_p / T = 0.01$	I_{FP}	100	mA
Power dissipation	$T_{amb} \leq 25^{\circ}\text{C}$	P_V	75	mW

Output (Detector)

Parameter	Test condition	Symbol	Value	Unit
Collector emitter voltage		V_{CE0}	70	V
Emitter collector voltage		V_{ECO}	7	V
Collector current		I_C	20	mA
Power dissipation	$T_{amb} \leq 25^\circ\text{C}$	P_V	75	mW

Electrical Characteristics

Coupler

$T_{amb} = 25^\circ\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Collector current	$V_{CE} = 5\text{ V}$, $I_F = 15\text{ mA}$	I_C	300	500		μA
Collector emitter saturation voltage	$I_F = 15\text{ mA}$, $I_C = 0.05\text{ mA}$	V_{CEsat}			0.4	V

Input (Emitter)

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Forward voltage	$I_F = 15\text{ mA}$	V_F		1.2	1.5	V
Reverse current	$V_R = 5\text{ V}$	I_R			10	μA
Junction capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$	C_j		50		pF

Output (Detector)

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Collector emitter voltage	$I_C = 1\text{ mA}$	V_{CE0}	70			V
Emitter collector voltage	$I_E = 100\ \mu\text{A}$	V_{ECO}	7			V
Collector-emitter cut-off current	$V_{CE} = 25\text{ V}$, $I_F = 0$, $E = 0$	I_{CEO}		10	100	nA

Switching Characteristics

$T_{amb} = 25^\circ\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Rise time	$I_C = 0.3\text{ mA}$, $V_{CE} = 5\text{ V}$, $R_L = 1000\ \Omega$ (see figure 2)	t_r		20.0	150	μs
Fall time	$I_C = 0.3\text{ mA}$, $V_{CE} = 5\text{ V}$, $R_L = 1000\ \Omega$ (see figure 2)	t_f		30.0	150	μs

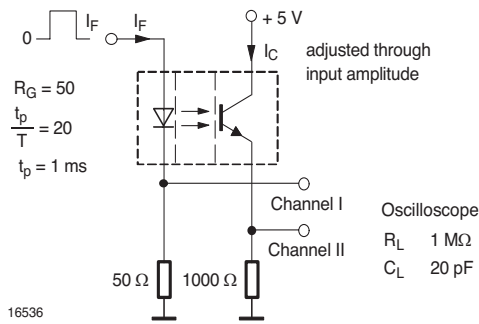


Figure 1. Test Circuit for t_r and t_f

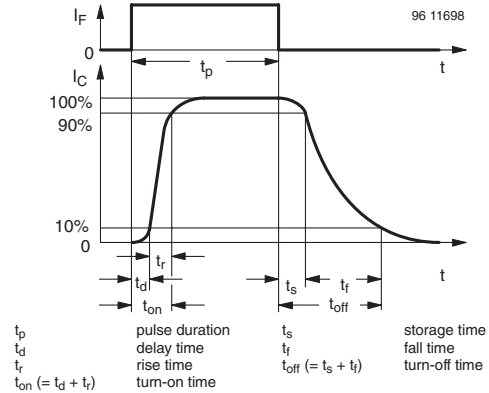


Figure 2. Switching Times

Typical Characteristics ($T_{amb} = 25\text{ }^\circ\text{C}$ unless otherwise specified)

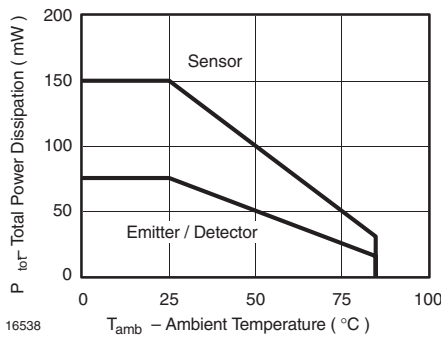


Figure 3. Derating diagram

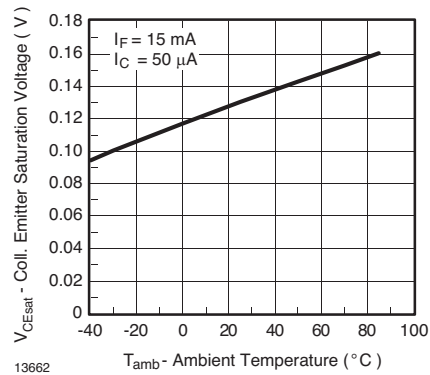


Figure 5. Collector Emitter Saturation Voltage vs. Ambient Temperature

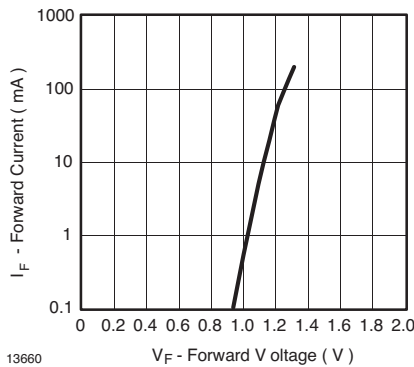


Figure 4. Forward Current vs. Forward Voltage

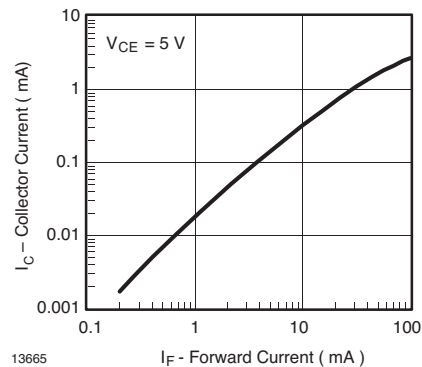


Figure 6. Collector Current vs. Forward Current

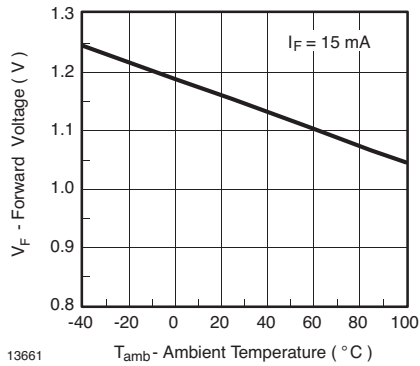


Figure 7. Forward Voltage vs. Ambient Temperature

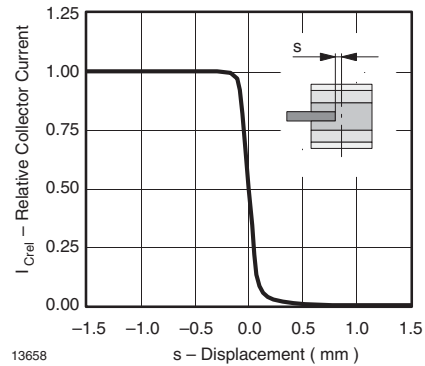


Figure 10. Relative Collector Current vs. Displacement

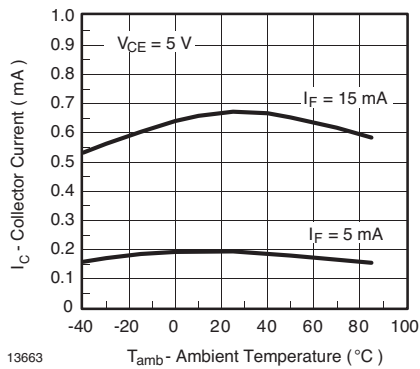


Figure 8. Collector Current vs. Ambient Temperature

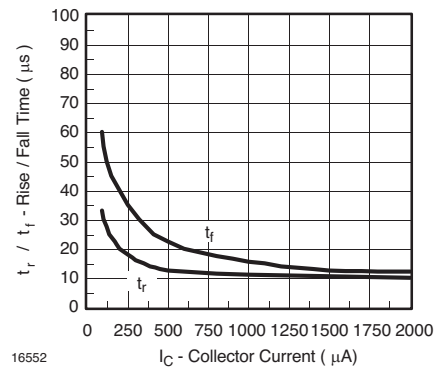


Figure 11. Rise/ Fall Time vs. Collector Current

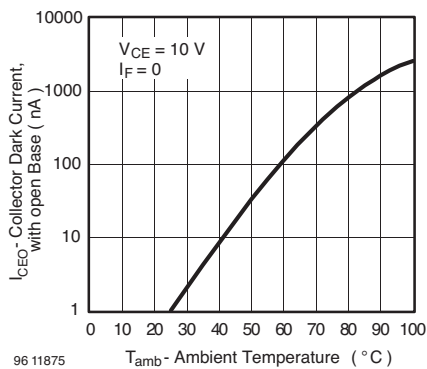


Figure 9. Collector Dark Current vs. Ambient Temperature

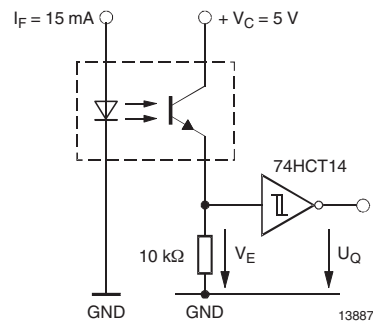


Figure 12. Application example

Reflow Solder Profiles

file (figure 10)

Floor Life: 12 month (level 2) or 168 hours (level 3)

Floor Conditions: $T_{amb} < 30\text{ }^{\circ}\text{C}$, RH < 60 %

Drying

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or Label. Devices taped on reel dry using recommended conditions 192 h @ 40 °C ($\pm 5\text{ }^{\circ}\text{C}$), RH < 5 % or 96 h @ 60 °C ($\pm 5\text{ }^{\circ}\text{C}$), RH < 5 %

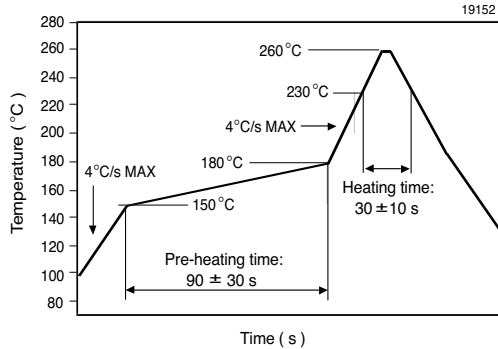


Figure 13. Lead-Free (Sn) Reflow Solder Profile

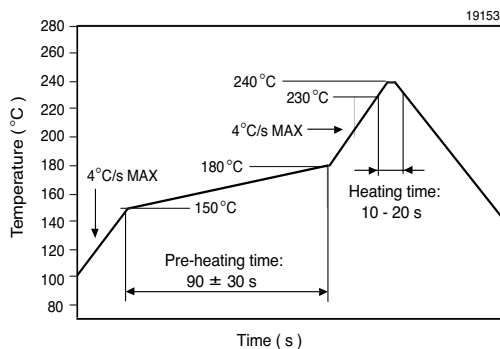


Figure 14. Lead Tin (SnPb) Reflow Solder Profile

Drypack

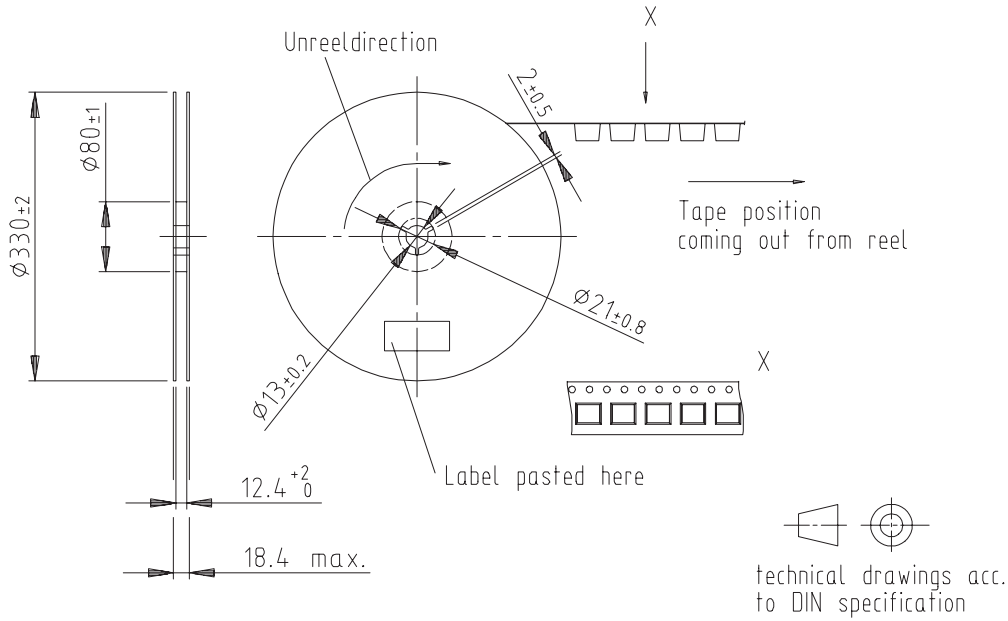
Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

Floor Life

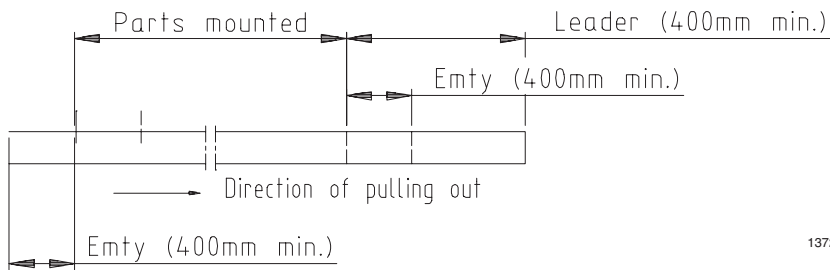
Floor life (time between soldering and removing from MBB) must not exceed the time indicated in J-STD-020. Acc. JEDEC, J-STD-020, TCPT1200X01 is released to Moisture Sensitivity Level 2, for use of Lead Tin (SnPb) Reflow Solder Profile (figure 11) or Level 3, for use of Lead-free (Sn) Reflow Solder Pro-

Dimensions of Reel and Tape

Reel-dimension and shape:

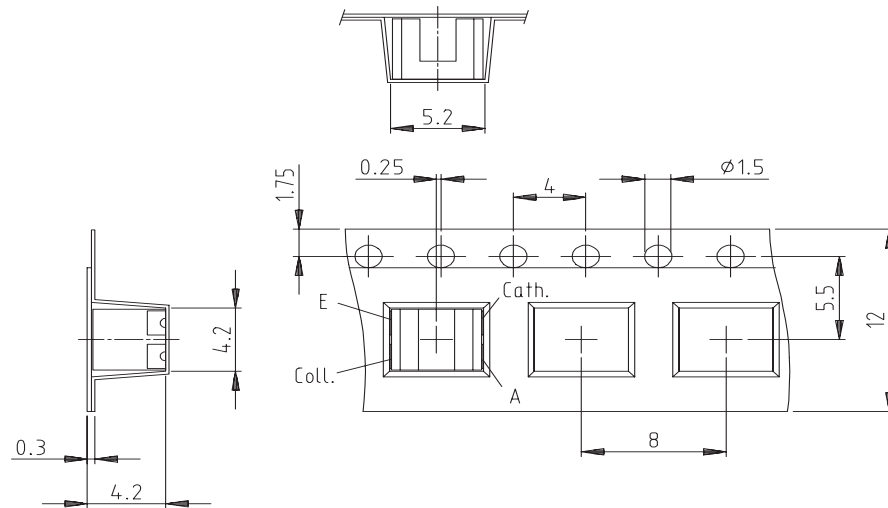


Leader and trailer tape:

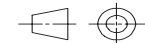


13722

Dimensions of Tape



Quantity per reel: 2000 pcs.



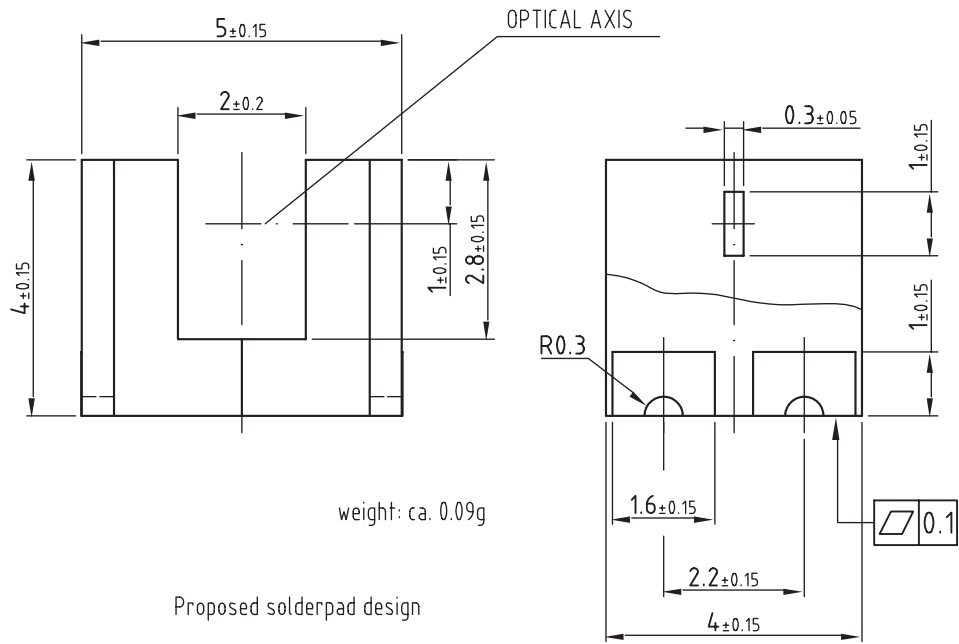
technical drawings acc.
to DIN specification
13721

TCPT1200X01

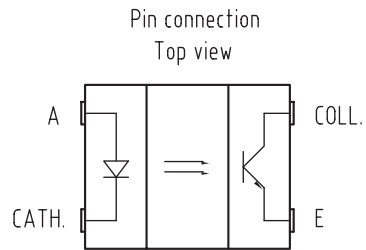
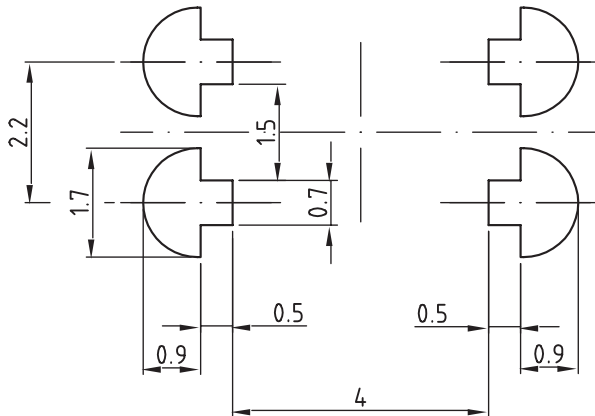
Vishay Semiconductors



Package Dimensions in mm

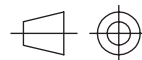


Proposed solderpad design



All dimensions in mm incl. burrs

Soldering terminal free from contamination and burr



technical drawings according to DIN specifications

Drawing-No.: 6.541-5043.01-4

Issue: 12; 17.12.04

19310

Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design
and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423



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